

L Number	Hits	Search Text	DB	Time stamp
1	1264	174/52.2.ccls.	USPAT	2004/04/30 15:35
2	414	174/52.2.ccls. and circuit adj1 board	USPAT	2004/04/30 15:40
3	210	(174/52.2.ccls. and circuit adj1 board) and resin	USPAT	2004/04/30 15:40
5	28	((174/52.2.ccls. and circuit adj1 board) and resin) and bond) and seal	USPAT	2004/04/30 15:36
4	86	((174/52.2.ccls. and circuit adj1 board) and resin) and bond	USPAT	2004/04/30 15:45
6	41	((174/52.2.ccls. and circuit adj1 board) and resin) and connector	USPAT	2004/04/30 15:40
7	909	174/260,267.ccls. and circuit adj1 board	USPAT	2004/04/30 15:44
8	343	(174/260,267.ccls. and circuit adj1 board) and resin	USPAT	2004/04/30 15:45
9	91	((174/260,267.ccls. and circuit adj1 board) and resin) and connector	USPAT	2004/04/30 15:45
10	941	257/787-796.ccls. and circuit adj1 board	USPAT	2004/04/30 15:44
11	582	(257/787-796.ccls. and circuit adj1 board) and resin	USPAT	2004/04/30 15:45
12	355	((257/787-796.ccls. and circuit adj1 board) and resin) and insulat\$4	USPAT	2004/04/30 15:45
13	45	((257/787-796.ccls. and circuit adj1 board) and resin) and insulat\$4) and connector	USPAT	2004/04/30 15:45
14	25	((257/787-796.ccls. and circuit adj1 board) and resin) and insulat\$4) and connector) and bond	USPAT	2004/04/30 15:45